

C3M0065100J


Transition Guide

Wolfspeed  SEPTEMBER 2024

900/1000V → 1200V TRANSITION

- Transitioning to 1200V class devices provides:
 - Increased $R_{DS(ON)}$ options
 - Increased package options
 - Improved availability and lead times
 - Broader range of applications supported
 - Increased scalability across power levels
- Comparable 1200V products offer potential drop-in solutions for existing designs

SUGGESTED REPLACEMENT OPTION 1


	C3M0065100J	C3M0075120J	Notes
Status	EOL issued Oct 2024	Active	Already qualified for production on 200mm
$V_{DS\ max}$ (V)	1000	1200	Increased voltage headroom
V_{GS} (V)	-4/15	-4/+15	Compatible gate drive levels
I_D (A)	32	30	
$R_{DS(on)}$ (m Ω)	65	75	Increased conduction losses
C_{oss} (pF)	70	58	Reduced output capacitance improves switching speed
C_{iss}/C_{rss}	152	695	Reduced impact of miller capacitance
Q_G (nC)	32	48	Increased gate power requirement
$R_{G(int)}$ (Ω)	3.5	9	Higher internal R_G may require reduced $R_{G(EXT)}$ in gate drive circuit
$R_{\theta JC}$ (C/W)	1.1	1.1	
Package	TO-263-7	TO-263-7	Fully Compatible
Pricing			Improved price

This replacement option is ideal for most designs

All parameters are typical values at 25 °C unless noted

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SUGGESTED REPLACEMENT OPTION 2: DESIGNS WITH EXTRA VOLTAGE MARGIN


	C3M0065100J	C3M0065090J	Notes
Status	EOL issued Oct 2024	Active	Already qualified for production on 200mm
$V_{DS\ max}$ (V)	1000	900	Lower V_{DS} rating may be acceptable in some applications
V_{GS} (V)	-4/15	-4/+15	Compatible gate drive levels
I_D (A)	32	35	
$R_{DS(on)}$ (m Ω)	65	65	
C_{oss} (pF)	70	66	
C_{iss}/C_{rss}	152	152	
Q_G (nC)	32	30	
$R_{G(int)}$ (Ω)	3.5	3.5	
$R_{\theta JC}$ (C/W)	1.1	1.1	
Package	TO-263-7	TO-263-7	Fully Compatible
Pricing			Improved price

This replacement part will perform extremely similarly if the application can tolerate 100V lower rated V_{DS}

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SUGGESTED REPLACEMENT OPTION 3: CONDUCTION LOSS DOMINATED DESIGNS

	C3M0065100J	C3M0040120J2/1	Notes
Status	EOL issued Oct 2024	Active	Already qualified for production on 200mm
$V_{DS\ max}$ (V)	1000	1200	Increased voltage headroom
V_{GS} (V)	-4/15	-4/+15	Compatible gate drive levels
I_D (A)	32	63	
$R_{DS(on)}$ (m Ω)	65	40	Reduced conduction loss
C_{oss} (pF)	70	100	
C_{iss}/C_{rss}	152	454	Reduced impact of miller capacitance
Q_G (nC)	32	91	Increased gate power requirement
$R_{G(int)}$ (Ω)	3.5	1.9	
$R_{\theta JC}$ (C/W)	1.1	0.39	Improved thermal impedance
Package	TO-263-7	TO-263-7 XL	Slightly different footprint. See following slide for details.
Pricing			Improved price

This replacement option may be used to achieve higher efficiency or more thermal margin if needed

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COMPARISON OF DIMENSIONS OF J, J1 AND J2 (TO-263-7)



- The J2 package utilizes a more industry standard footprint and takes less PCB space
- Depending on the existing footprint in the PCB layout, small changes may be needed to provide optimal pad sizing for soldering

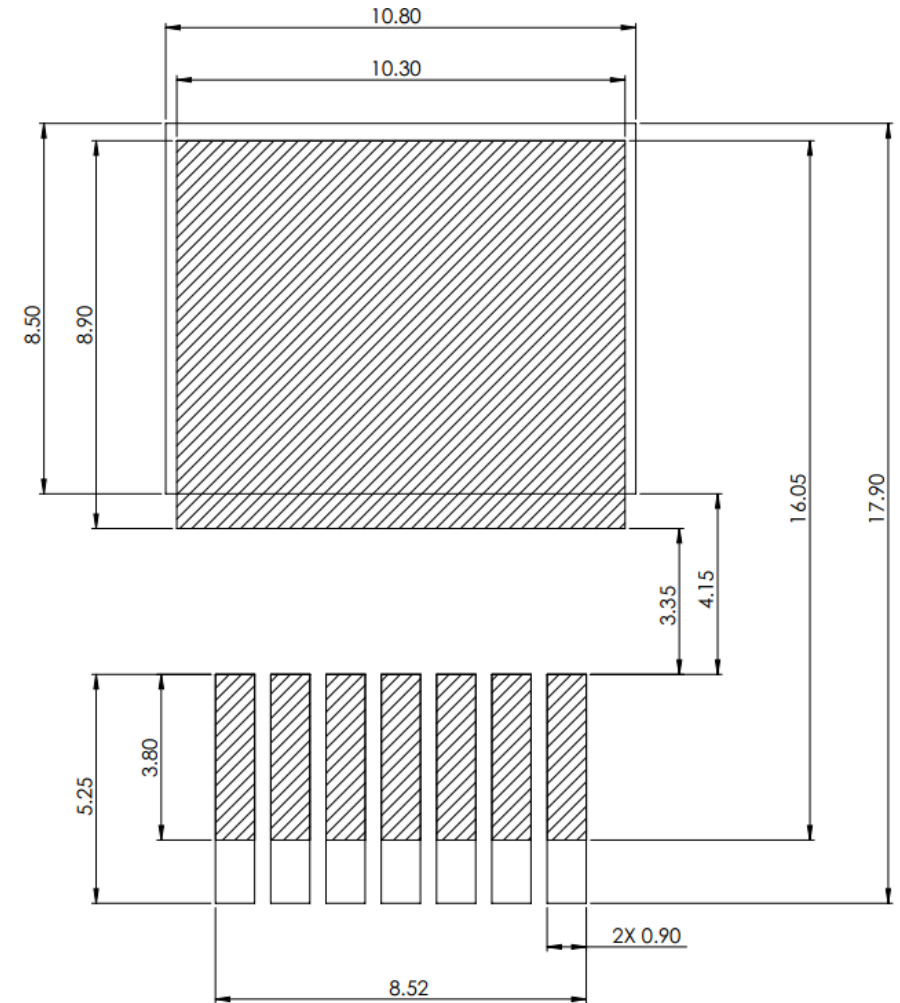
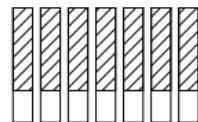
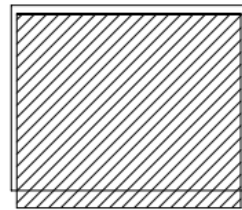
Item All dimensions in mm	WS-J	WS-J1	WS-J2
Device Length	16.178	16.178	15.07
Device Width	10.18	10.18	10
Device Height	4.435	4.435	4.5
Drain Pad Length - Device	6.218	8.018	7.78
Contact Pin Length - Device	2.512	2.7	2.7
Creepage on Device	6.87	4.83	4.65
Creepage on Board (Based on Recommended Landing Pad)	6.99	4.15	4.15
Drain Solder Pad Length - PCB	6.538	8.0	8.5
Drain Solder Pad Width - PCB	10.480	10.8	10.8
Contact Pin Solder Pad Length - PCB	3.4	4.7	5.25*
Contact Pin Solder Pad Width - PCB	0.9	0.8	0.9

*Note: Considered extended pad for the comparison

J2 RECOMMENDED LANDING PAD

The footprint shown here includes a variant with extended pad sizes that will accommodate the J, J1, and J2 package for maximum flexibility

-  J2 PACKAGE LANDING PAD
-  EXTENDED PAD TO FIT J AND J1 PACKAGE



NOTE: J2 LANDING PAD WAS DESIGNED FOLLOWING IPC 7351 GUIDELINES

NEXT STEPS

- Samples of recommended replacements available through your [Wolfspeed sales team](#), or at our online [Sample Center](#)
- Ask any technical questions to your Wolfspeed FAE or through our [Power Applications Forum](#)
- Utilize [SpeedFit™](#) to simulate the performance of the recommended replacement devices
 - Keep in mind, dynamic behavior may be different, requiring a different gate resistor value
- The [SpeedVal™ Kit](#) evaluation platform may be utilized to compare the performance and switching behavior

A large, stylized grey graphic of a wolf's head, facing right, with sharp, pointed ears and a snout. The graphic is semi-transparent and serves as a background for the text.

THANK YOU